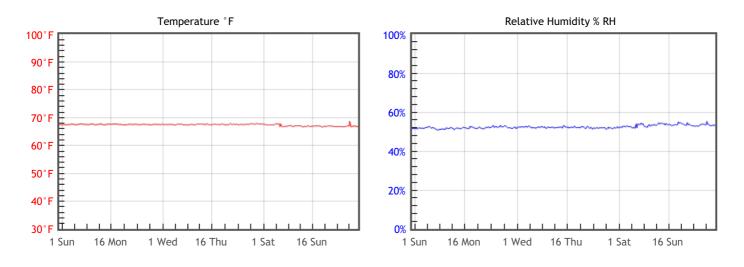
## **GalleryA**

CJH • Exhibitions • Ground\_floor • Popper\_Gallery(A) Center for Jewish History

## **Preservation Environment Evaluation**

Type of Decay	Risks & Metrics	Evaluation & General Comments		
Natural Aging Chemical decay of organic materials	RISK TWPI = 43	Accelerated rate of chemical decay in all organic materials due to the cumulative effects of temperature and humidity, with especially high risk for fast decaying organic materials such as acidic paper, color photographs and cellulosic plastics.		
Mechanical Damage Physical damage to hygroscopic materials	GOOD  % DC = 0.05 % EMC min = 9.6 % EMC max = 9.8	Minimal risk of physical damage to most hygroscopic materials such as paintings, rare books and furniture.		
Mold Risk  Mold growth in area or on collection objects	GOOD  MRF = 0	Minimal risk of mold growth.		
Metal Corrosion  Corrosion of metal  components or objects	OK % EMC max = 9.8	Generally OK, but archeological or salt-encrusted metals may corrode due to extended periods of moderately high levels of humidity.		

## **Graphs**



## **Statistics**

Temperature		Relative Humidity		Dew Point	
T°F Mean	67.4	%RH Mean	52	DP°F Mean	49.4
T°F Median	67.5	%RH Median	52	DP°F Median	49.3
T°F Stdev	0.3	%RH Stdev	1	DP°F Stdev	0.3
T°F Min	66.4	%RH Min	50	DP°F Min	48.5
T°F Max	69.8	%RH Max	58	DP°F Max	52.8